

TOSHIBA BI-DIRECTIONAL TRIODE THYRISTOR SILICON PLANAR TYPE

SM6G45, SM6J45, SM6G45A, SM6J45A

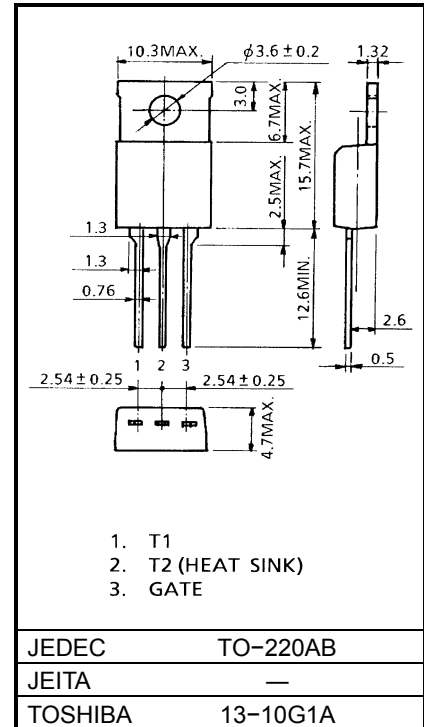
AC POWER CONTROL APPLICATIONS

- Repetitive Peak Off-State Voltage : $V_{DRM} = 400, 600V$
- R.M.S ON-State Current : $I_T (RMS) = 6A$
- High Commutating (dv / dt)

MAXIMUM RATINGS

| CHARACTERISTIC | | SYMBOL | RATING | UNIT |
|---|-------------------|-----------------------------|-----------|------------------|
| Repetitive Peak Off-State Voltage | SM6G45 SM6G45A | V _{DRM} | 400 | V |
| | SM6J45 SM6J45A | | 600 | |
| R.M.S On-State Current (Full Sine Waveform Tc = 104°C) | | I _T (RMS) | 6 | A |
| Peak One Cycle Surge On-State Current (Non-Repetitive) | | I _{TSM} | 60 (50Hz) | A |
| | | | 66 (60Hz) | |
| I ² _t Limit Value | | I ² _t | 18 | A ² s |
| Critical Rate of Rise of On-State Current | | di / dt | 50 | A / μs |
| Peak Gate Power Dissipation | | P _{GM} | 5 | W |
| Average Gate Power Dissipation | | P _G (AV) | 0.5 | W |
| Peak Gate Voltage | | V _{GM} | 10 | V |
| Peak Gate Current | | I _{GM} | 2 | A |
| Junction Temperature | | T _j | -40~125 | °C |
| Storage Temperature Range | | T _{stg} | -40~125 | °C |

Unit: mm

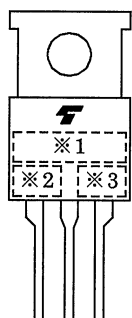


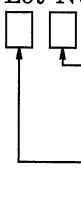
Weight: 2.0g

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

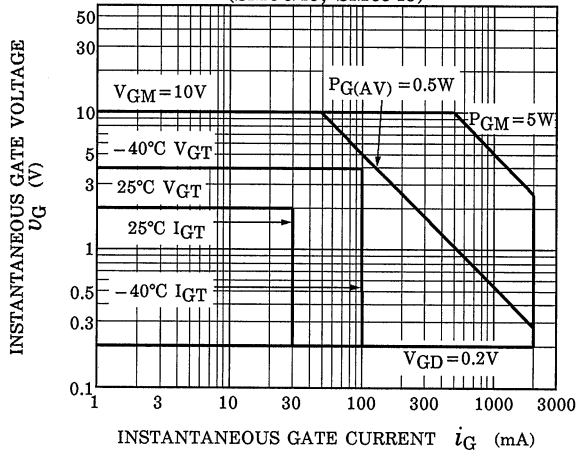
| CHARACTERISTIC | | | SYMBOL | TEST CONDITION | | MIN | TYP. | MAX | UNIT |
|---|--------------------|--------------------|-----------------------|--|------------------|-----|------|-----|--------|
| Repetitive Peak Off-State Current | | | I _{DRM} | V _{DRM} = Rated, T _j = 125°C | | — | — | 2 | mA |
| Gate Trigger Voltage | SM6G45 SM6J45 | I | V _{GT} | V _D = 12V R _L = 20Ω | T2 (+), Gate (+) | — | — | 2 | V |
| | | II | | | T2 (+), Gate (–) | — | — | 2 | |
| | | III | | | T2 (–), Gate (–) | — | — | 2 | |
| | | IV | | | T2 (–), Gate (+) | — | — | — | |
| | SM6G45A SM6J45A | I | | | T2 (+), Gate (+) | — | — | 1.5 | |
| | | II | | | T2 (+), Gate (–) | — | — | 1.5 | |
| | | III | | | T2 (–), Gate (–) | — | — | 1.5 | |
| | | IV | | | T2 (–), Gate (+) | — | — | — | |
| Gate Trigger Current | SM6G45 SM6J45 | I | I _{GT} | V _D = 12V R _L = 20Ω | T2 (+), Gate (+) | — | — | 30 | mA |
| | | II | | | T2 (+), Gate (–) | — | — | 30 | |
| | | III | | | T2 (–), Gate (–) | — | — | 30 | |
| | | IV | | | T2 (–), Gate (+) | — | — | — | |
| | SM6G45A SM6J45A | I | | | T2 (+), Gate (+) | — | — | 20 | |
| | | II | | | T2 (+), Gate (–) | — | — | 20 | |
| | | III | | | T2 (–), Gate (–) | — | — | 20 | |
| | | IV | | | T2 (–), Gate (+) | — | — | — | |
| Peak On-State Voltage | | | V _{TM} | I _{TM} = 9A | | — | — | 1.5 | V |
| Gate Non-Trigger Voltage | | | V _{GD} | V _D = Rated, T _c = 125°C | | 0.2 | — | — | V |
| Holding Current | | | I _H | V _D = 12V, I _{TM} = 1A | | — | — | 50 | mA |
| Thermal Resistance | | | R _{th (j-c)} | Junction to Case, AC | | — | — | 2.5 | °C / W |
| Critical Rate of Rise of Off-State Voltage at Commutation | | SM6G45 SM6J45 | (dv / dt) c | V _{DRM} = 400V, (di / dt) c = –3.3A / ms T _j = 125°C | | 10 | — | — | V / μs |
| | | SM6G45A SM6J45A | | | | 4 | — | — | |

MARKING

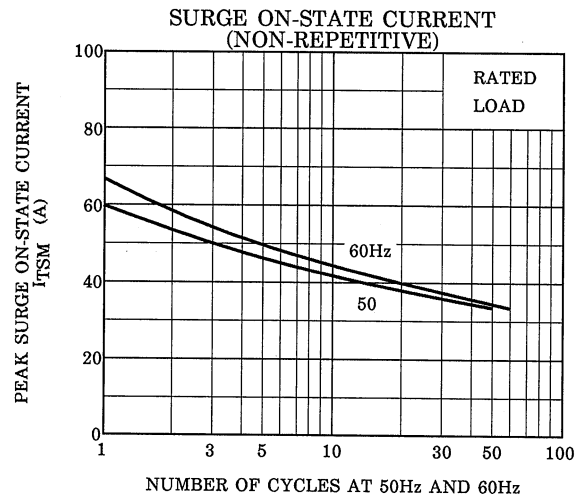
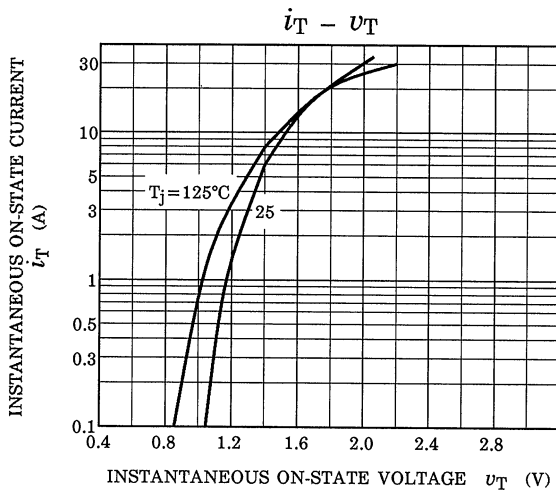
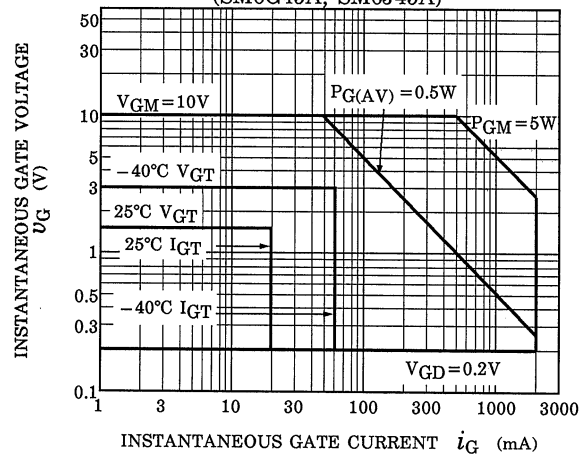


| NUMBER | SYMBOL | | MARK |
|--------|---|------------------|--|
| * 1 | TYPE | SM6G45, SM6G45A | M6G45 |
| | | SM6J45, SM6J45A | M6J45 |
| * 2 | | SM6G45A, SM6J45A | A |
| * 3 | Lot Number  | | Example 8A : January 1998 8B : February 1998 8L : December 1998 |

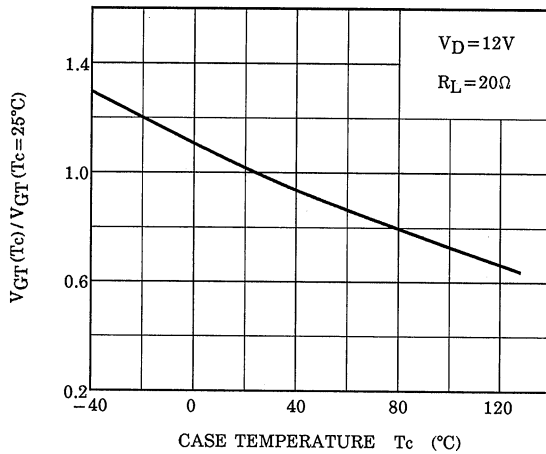
GATE TRIGGER CHARACTERISTIC
(SM6G45, SM6J45)



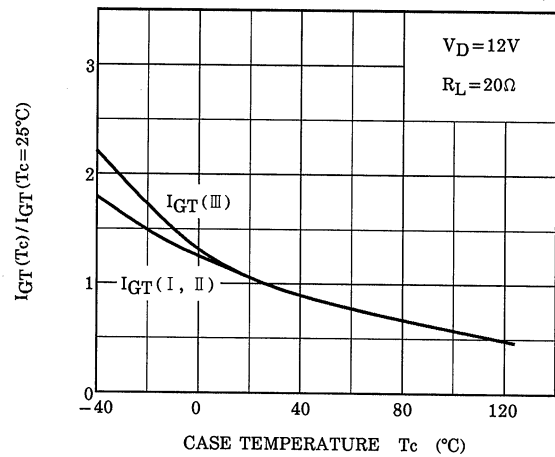
GATE TRIGGER CHARACTERISTIC
(SM6G45A, SM6J45A)

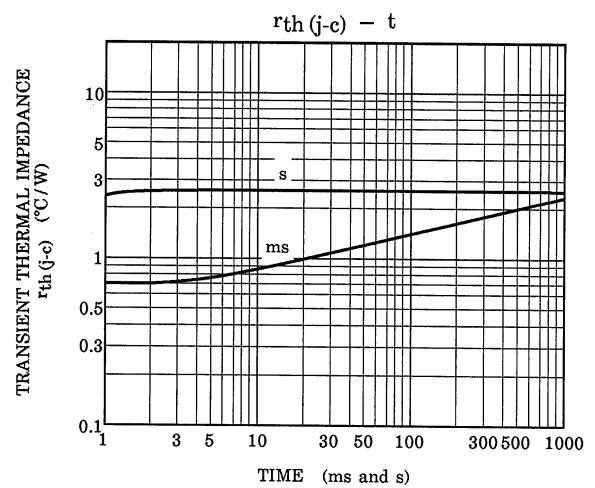
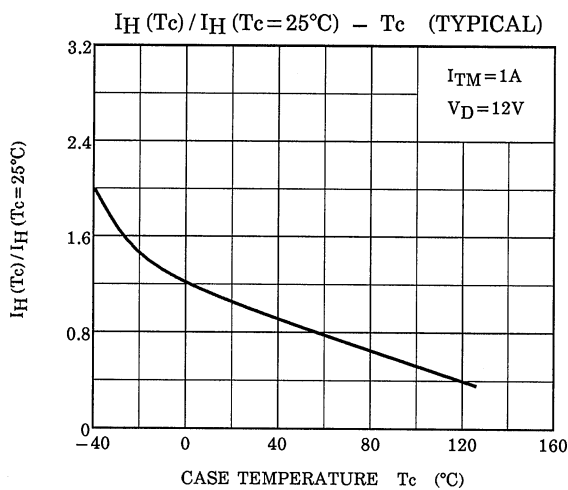
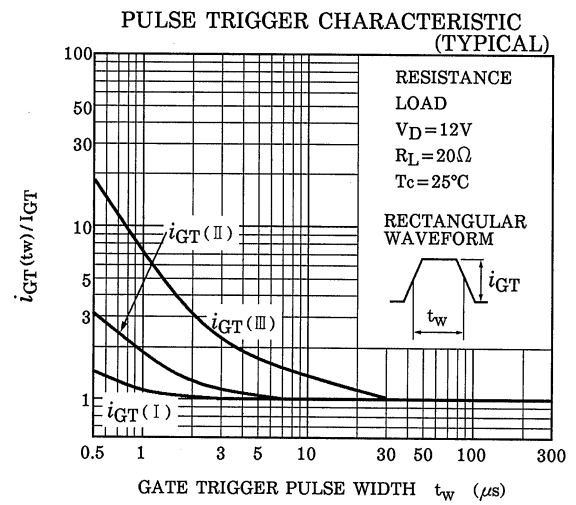
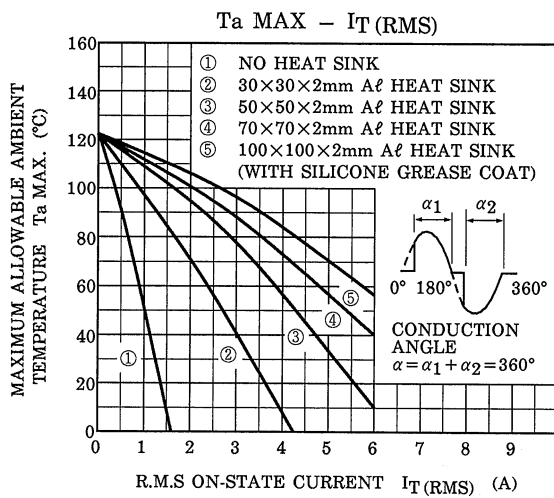
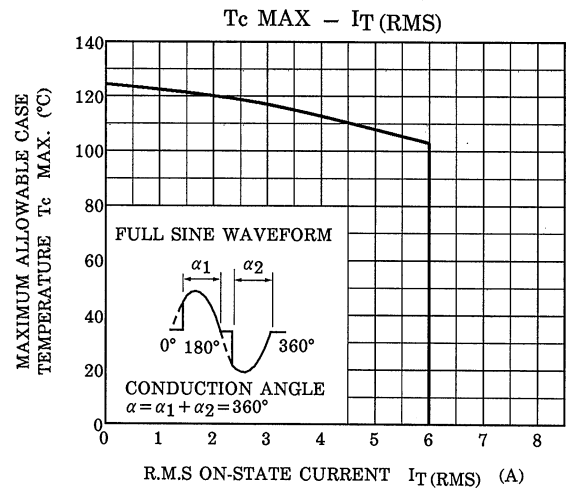
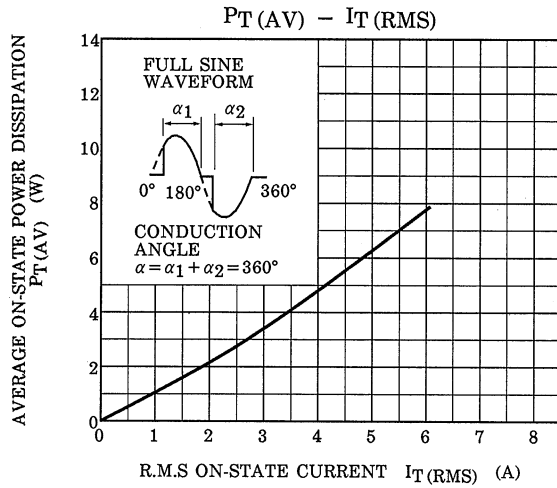


$V_{GT}(T_c) / V_{GT}(T_c = 25^\circ\text{C}) - T_c$ (TYPICAL)



$I_{GT}(T_c) / I_{GT}(T_c = 25^\circ\text{C}) - T_c$ (TYPICAL)





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